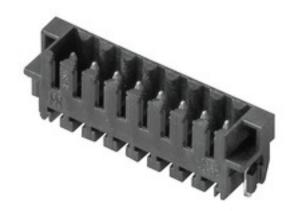


Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

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Product image





















High-temperature-resistant male header, 3.50 mm pitch.

- Plugging direction parallel (90°), straight 180° or angled (135°) to PCB
- Housing variants: closed side (G), screw flange (F), solder flange (LF) or snap-on solder flange (RF)
- Optimised for the SMT process
- Pin length 3.2 mm universal for all soldering methods
- Pin length 1.5 mm optimised for reflow soldering methods
- Packed either in a box (BX) or tape-on-reel (RL)
- Male header can be coded

General ordering data

Version	PCB plug-in connector, male header, Clip-on flange, THT/THR solder connection, 3.50 mm, Number of poles: 12, 180°, Solder pin length (I): 1.5 mm, tinned, black, Tape
Order No.	<u>2568170000</u>
Туре	SL-SMT 3.50/12/180RF 3.2SN BK BX
GTIN (EAN)	4050118578386
Qty.	50 pc(s).
Product data	IEC: 320 V / 15 A UL: 300 V / 10 A
Packaging	Tape



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Technical data

Dimensions and weights

Depth	7.4 mm	Depth (inches)	0.291 inch
Height of lowest version	11.1 mm	Net weight	3.828 g

System specifications

Product family	OMNIMATE Signal - series	Type of connection	
	BL/SL 3.50	.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	Board connection
Mounting onto the PCB	THT/THR solder	Pitch in mm (P)	
	connection		3.5 mm
Pitch in inches (P)	0.138 inch	Outgoing elbow	180°
Number of poles	12	Number of solder pins per pole	1
Solder pin length (I)	1.5 mm	Solder pin length tolerance	0 / -0.3 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0,03 mm
Solder eyelet hole diameter (D)	1.4 mm	Solder eyelet hole diameter tolerance (D)+ 0,1 mm	
Outside diameter of solder pad	2.3 mm	Template aperture diameter	2.1 mm
L1 in mm	38.5 mm	L1 in inches	1.516 inch
Number of rows	1	Pin series quantity	1
Touch-safe protection acc. to DIN VDE	Safe from back-of-hand	Touch-safe protection acc. to DIN VDE	
57 106	touch	0470	IP 10
Volume resistance	≤5 mΩ	Can be coded	Yes
Plugging force/pole, max.	6 N	Pulling force/pole, max.	6 N

Material data

Insulating material	LCP GF	Colour	black
Colour chart (similar)	RAL 9011	Insulating material group	Illa
Comparative Tracking Index (CTI)	≥ 175	Moisture Level (MSL)	1
UL 94 flammability rating	V-0	Contact material	CuSn
Contact surface	tinned	Layer structure of solder connection	23 µm Ni
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
Temperature range, installation, min.	-30 °C	Temperature range, installation, max.	100 °C

Rated data acc. to IEC

tested acc. to standard		Rated current, min. number of poles	
	IEC 60664-1, IEC 61984	(Tu=20°C)	15 A
Rated current, max. number of poles		Rated current, min. number of poles	
(Tu=20°C)	12 A	(Tu=40°C)	13 A
Rated current, max. number of poles		Rated voltage for surge voltage class /	
(Tu=40°C)	10 A	pollution degree II/2	320 V
Rated voltage for surge voltage class /		Rated voltage for surge voltage class /	
pollution degree III/2	160 V	pollution degree III/3	160 V
Rated impulse voltage for surge voltage		Rated impulse voltage for surge voltage	
class/ pollution degree II/2	2.5 kV	class/ pollution degree III/2	2.5 kV
Rated impulse voltage for surge voltage			
class/ contamination degree III/3	2.5 kV		

Rated data acc. to CSA

Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A



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Technical data

Rated data acc. to UL 1059

Rated voltage (Use group B / UL 1059)		Rated voltage (Use group D / UL 1059)		
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group D / UL 1059)	10 A	
Packing				
	_			
Packaging	Tape	VPE length	0 m	
VPE width	0 m	VPE height	0 m	
Γape reel diameter ∅ (A)	330 mm	Surface resistance	$Rs = 10^9 - 10^{12} \Omega$	
Classifications				
ETIM 6.0	EC002637	ETIM 7.0	EC002637	
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02	
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01	
Important note				
IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative propertie in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.			
Notes	Gold-plated contact surfaces on request			
	Rated current related	to rated cross-section & min. No. of poles.		
	• Diameter of solder eyelet D = 1.4+0.1mm			
	• Solder eyelet diameter D = 1.5 + 0.1 mm, from 9 poles			
	• P on drawing = pitch			
	 Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. 			
	Long term storage of	the product with average temperature of 50 °C and aver	age humidity 70%, 36 month	
Approvals				
Polic	Conform			
ROHS	Conform			



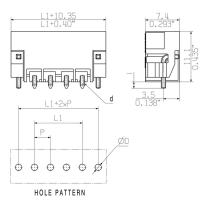
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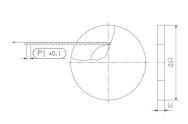
Drawings

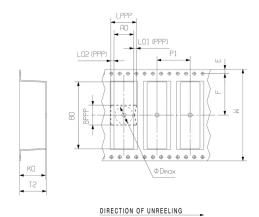
Dimensional drawing



Dimensional drawing

Dimensional drawing





Example of use

Example of use







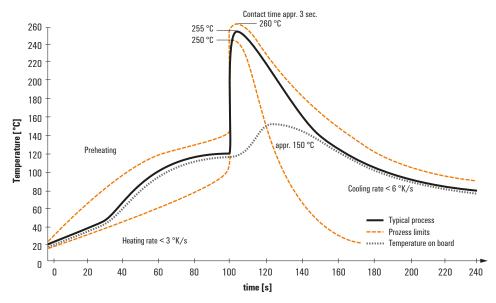
Recommended wave solderding profiles

Weidmüller Interface GmbH & Co. KG

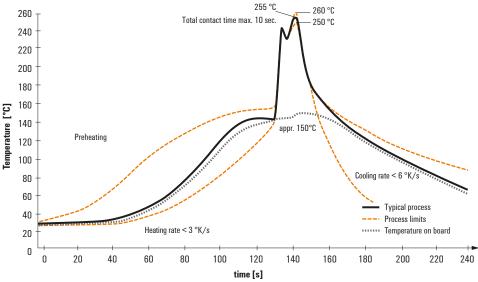
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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

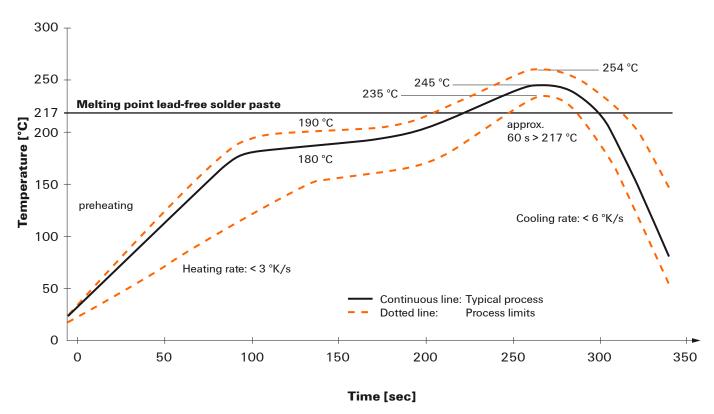


Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- · Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- · Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.